



# The upgrades of the CMS detector for the HL-LHC

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**On behalf of the CMS Collaborations**

**University of Minnesota**

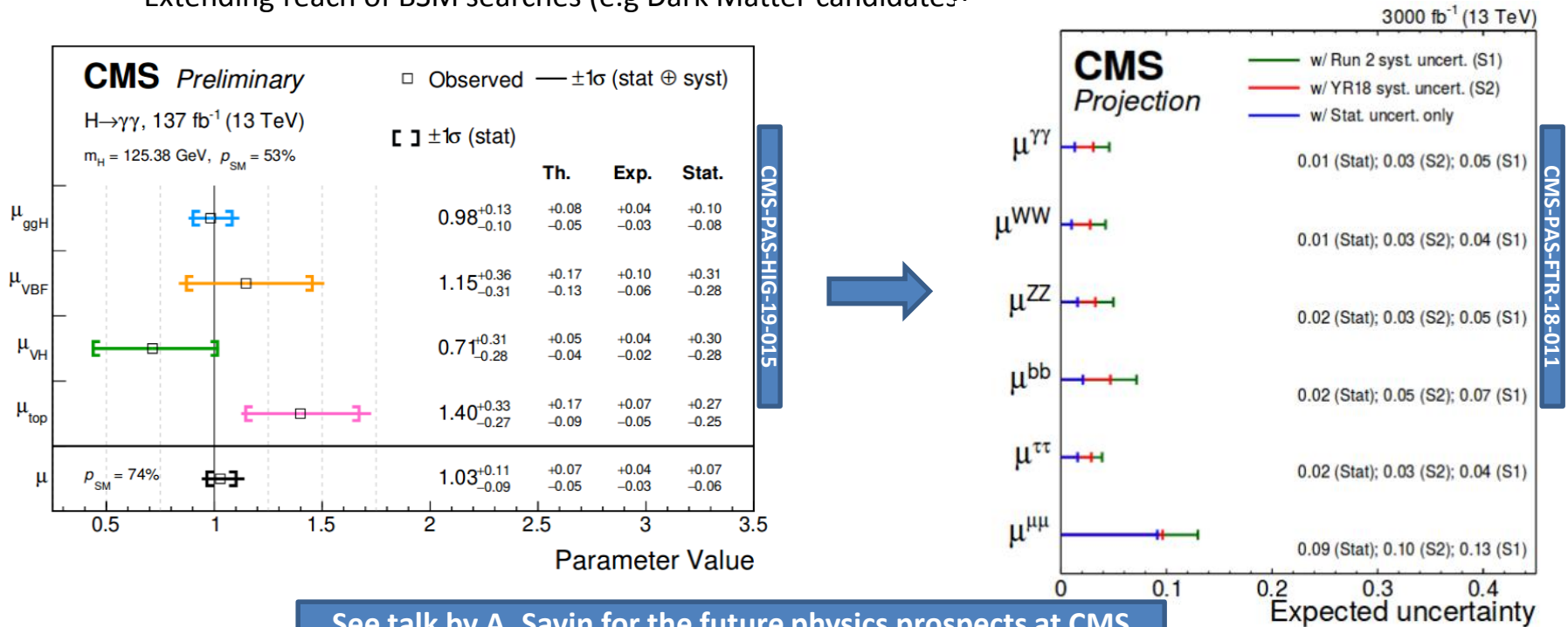
**9<sup>th</sup> international conference on New Frontiers in Physics**  
**4-12 September 2020**

\*\*A Zoom/Vidyo/Skype meeting can be setup on request

# The High Luminosity LHC: Physics motivation



- Runs 1 and 2 of the LHC have yielded a rich harvest of physics results (> 1000 papers) :
  - From the discovery of the Higgs boson to a comprehensive study of its properties with high precision.
  - Observation of rare decays like  $B_s^0 \rightarrow \mu^+\mu^-$  and rare processes like heavy triple boson production
  - An extensive set of searches for hints of physics beyond the standard model (BSM).
- However a decisive increase of the LHC luminosity in order to meaningfully improve on the current results in a reasonable timeframe:
  - O(1%) precision on SM Higgs couplings
  - Rare Higgs Decays (e.g  $H \rightarrow \mu\mu$ ) and production ( e.g. HH )
  - Extending reach of BSM searches (e.g Dark Matter candidates)

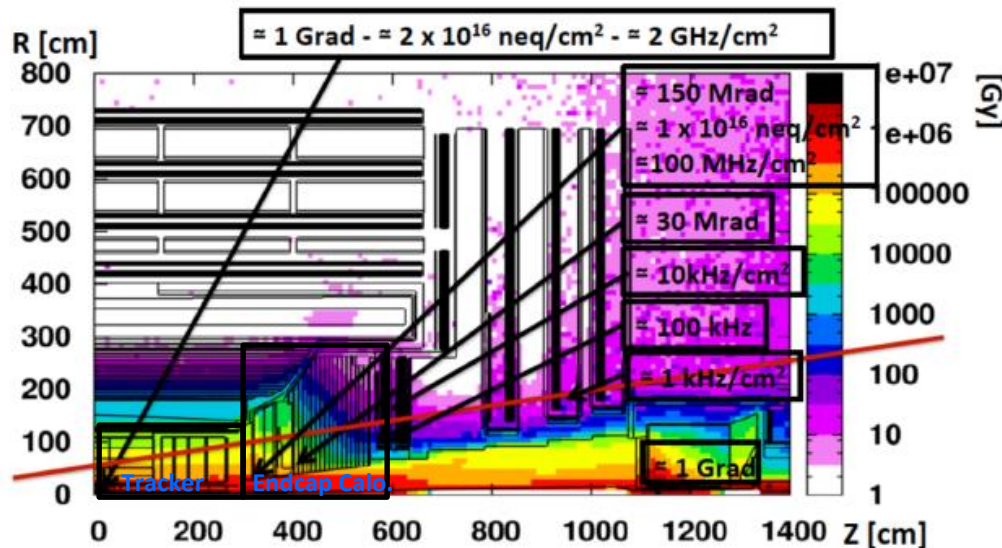


See talk by A. Savin for the future physics prospects at CMS

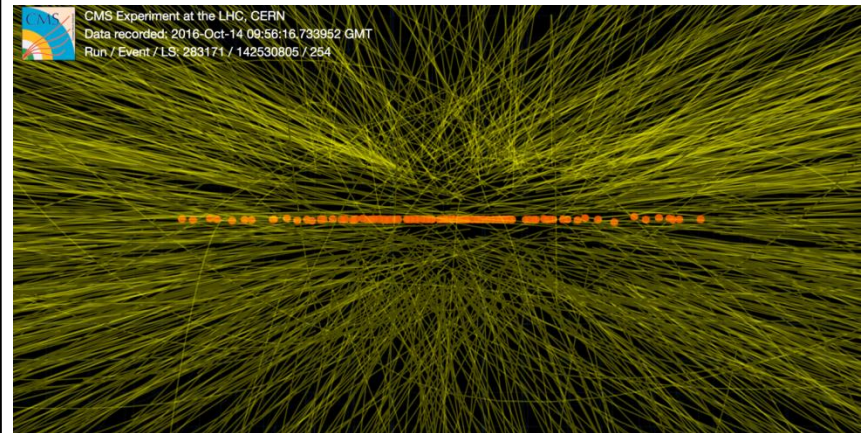
# The High Luminosity LHC: Challenges



The HL-LHC environment presents unprecedented challenges to the CMS physics program of searching for New Physics through Precision Measurements and Direct Searches for Rare Processes.



Simulation: Total of  $3 \text{ ab}^{-1}$  with  $300 \text{ fb}^{-1}/\text{year}$



A typical event from a 2016 High PU ( $\langle\mu\rangle = 100$ ) run

HIGH RADIATION(due to high integrated lumi.)

- Radiation levels up to  $2 \times 10^{16} \text{ neq}/\text{cm}^2$  or 1 Grad in the forward region or close to the collision point.

HIGH PILEUP(due to high instant. lumi.)

- Multiple collision per event: 140--200



The basic goal of the upgrades to the CMS detector for operations at the HL-LHC is to maintain/improve the excellent performance of the detectors in terms of efficiency, resolution, and background rejection for all the physics objects used in the analysis of the data.

- **Radiation Environment**

- The complete replacement of the Tracker and End-Cap Calorimeter systems with increased use of radiation tolerant Si
- Colder operation of the Barrel ECAL (APD Noise Mitigation)
- Major electronics overhaul and consolidation of the Barrel Calorimeters and Muon systems

- **High Pile Up**

- Improved granularity
- Precision time to separate collisions in time as well as space

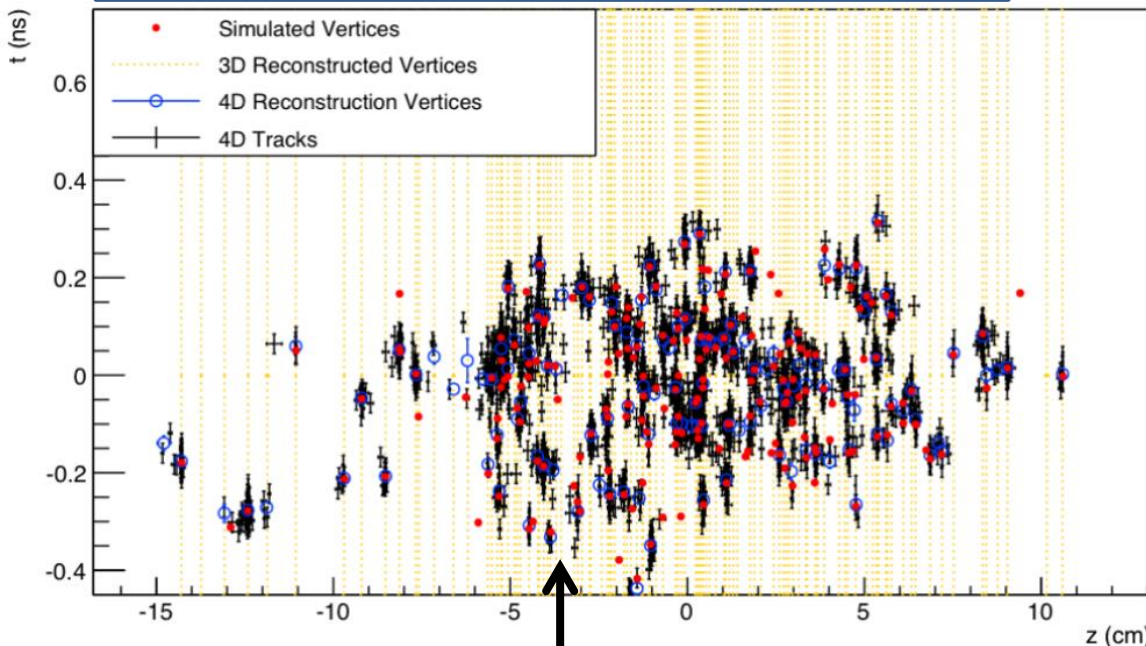
- **High Luminosity**

- A complete overhaul of the Trigger and DAQ systems to enable faster processing of the data in real time

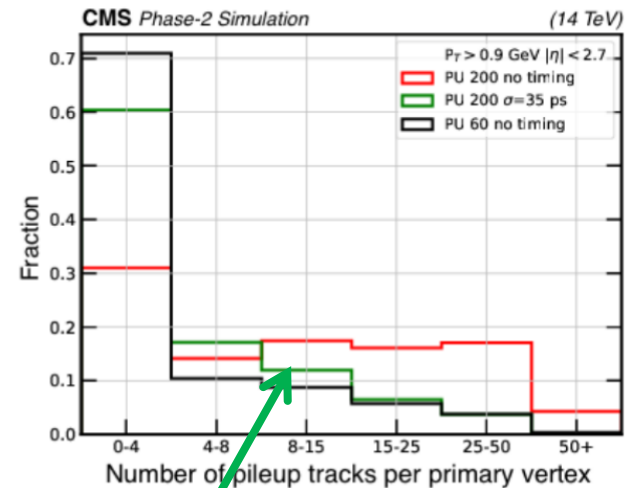


# Precision timing as a tool to mitigate pileup

Collision vertices within a bunch crossing at 200 PU.



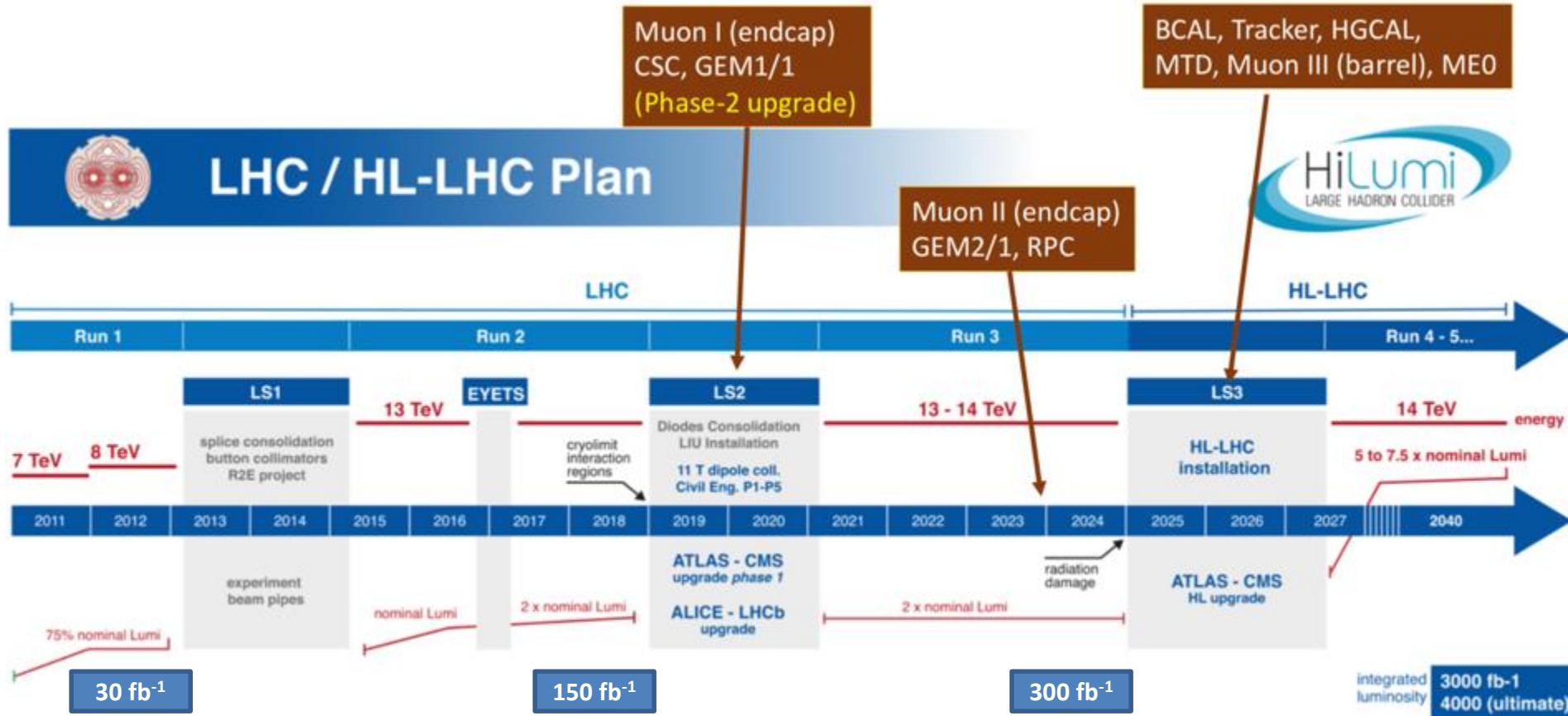
Pileup tracks incorrectly associated to the interaction vertex



- **Key idea:** Under HL-LHC conditions timing information can be used to “separate” pileup vertices that otherwise appear to be “merged” in 3D space.
  - This separation improves with the time resolution: ~30 ps resolution is already effective.
- The upgraded Barrel ECAL will provide precision timing information for high energy photon showers.
- The new Endcap calorimeter will provide precision timing information for both high energy photons and hadrons.
- **The MIP Timing Detector (MTD) will be used at the HL-LHC for precision timing of tracks**



# CMS HL-LHC Upgrade: Timeline



## HL-LHC TECHNICAL EQUIPMENT:



**RUN 2:**  
 Design  $L = 10^{34} \text{ cm}^2\text{s}^{-1}$   
 <Pileup>  $\sim 34$

**RUN 3:**  
 Design  $L = 2 \times 10^{34} \text{ cm}^2\text{s}^{-1}$   
 Exp. <Pileup>  $\sim 60$

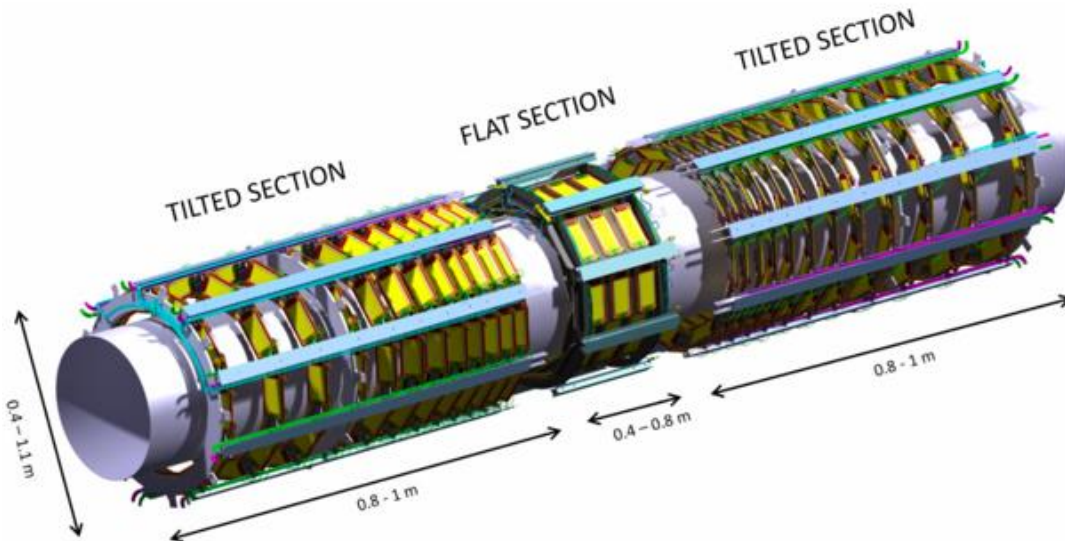
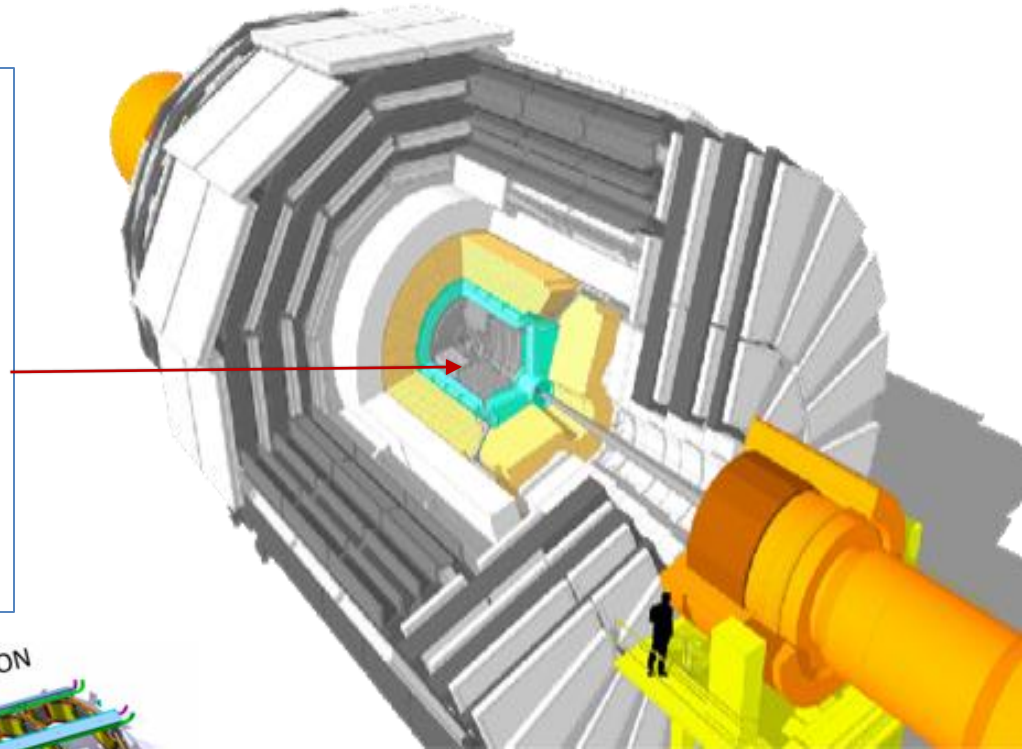
**HL-LHC:**  
 Design  $L = 5-7.5 \times 10^{34} \text{ cm}^2\text{s}^{-1}$   
 Exp. <Pileup>  $\sim 140-200$

# The CMS tracker for the HL-LHC

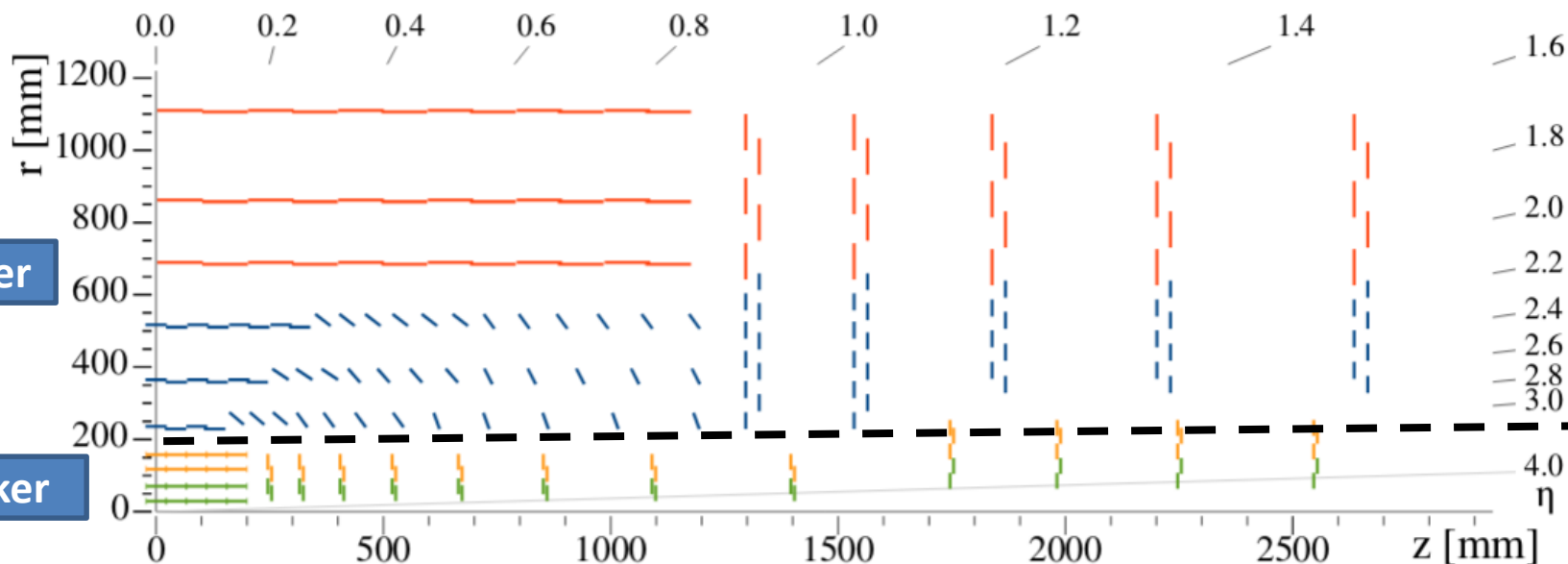


Key features:

- More granular
- Lower material budget
- Extended coverage to  $\eta \approx 3.8$
- Tracking included in L1 Trigger for the first time



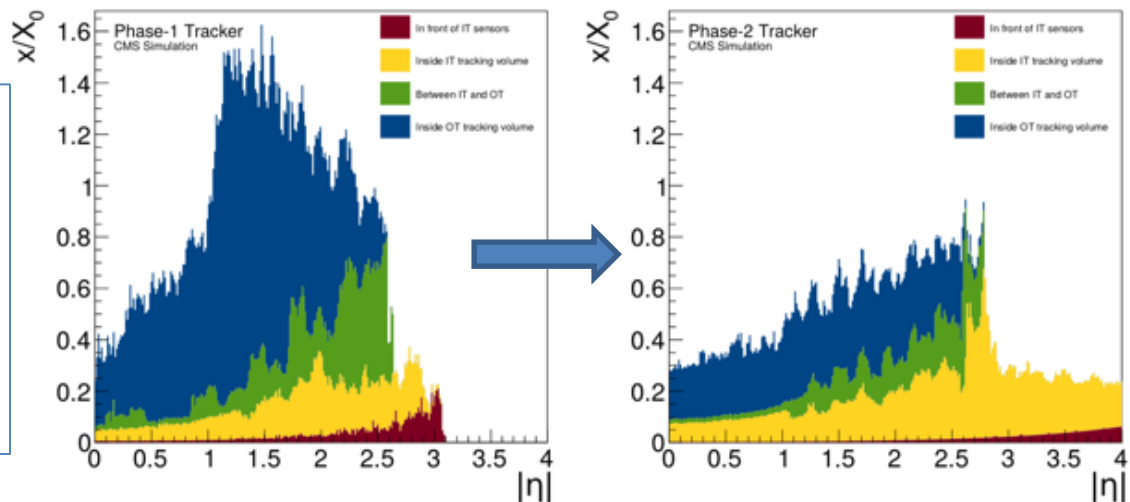
# CMS HL-LHC Tracker: Layout and Material Budget



Outer Tracker

Inner Tracker

- Significant reduction in the material budget.
  - Improves both the tracker and calorimetric performance



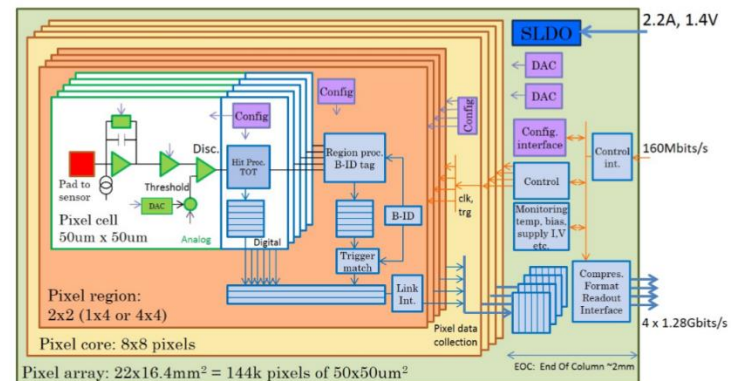
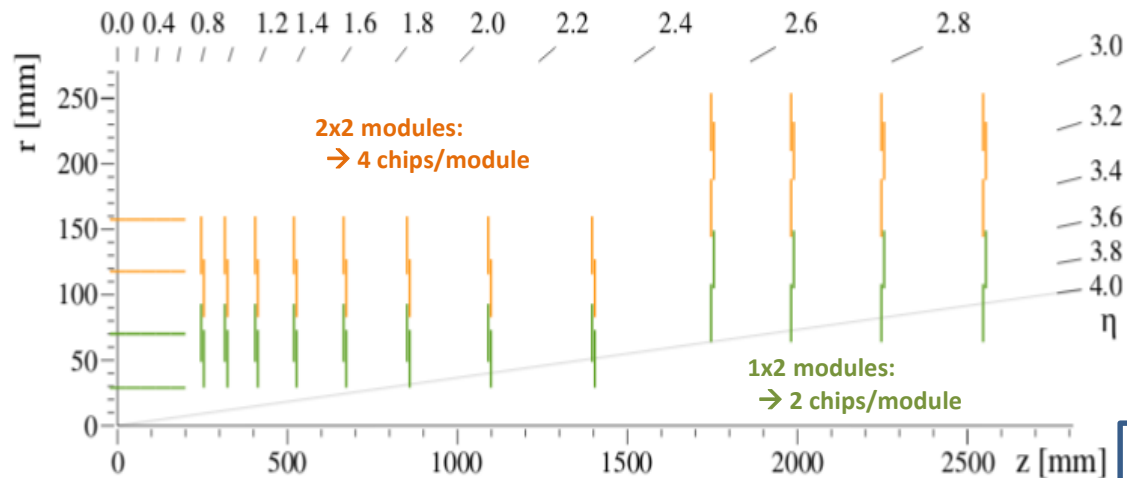


# Inner Tracker : Overview



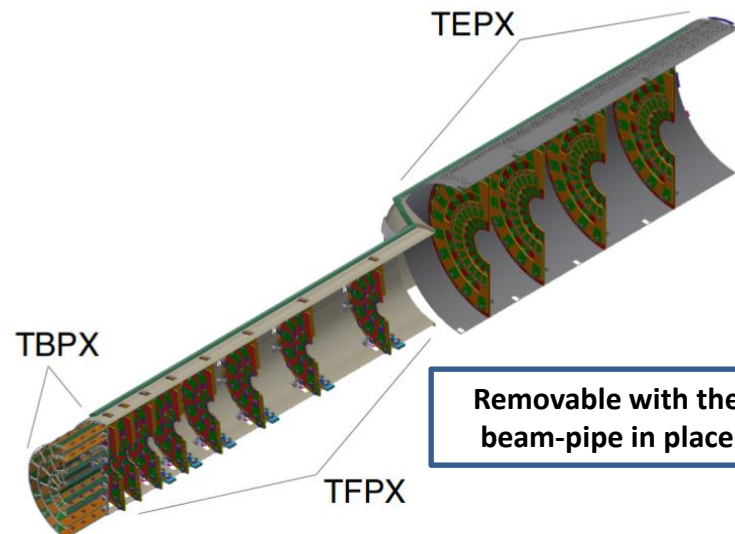
The inner tracker must tolerate a radiation dose of  $\sim 1$  GRad , with a hit rate  $\leq 3$  GHz/cm<sup>2</sup>

→ Pixel size of  $25 \mu\text{m} \times 100 \mu\text{m}$  and  $50 \mu\text{m} \times 50 \mu\text{m}$

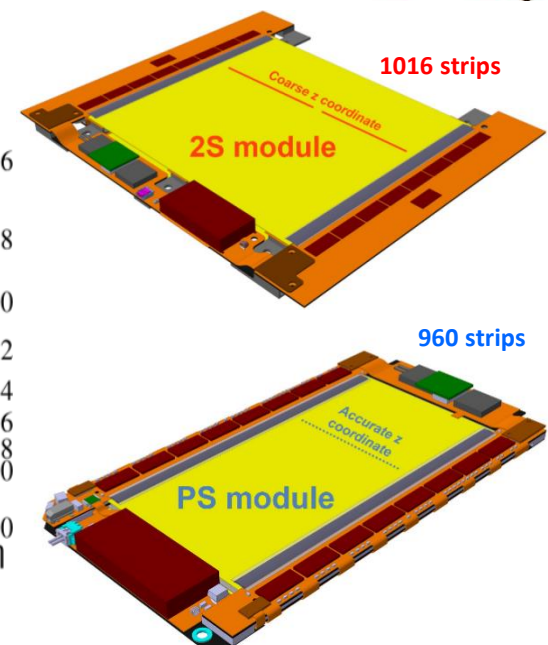
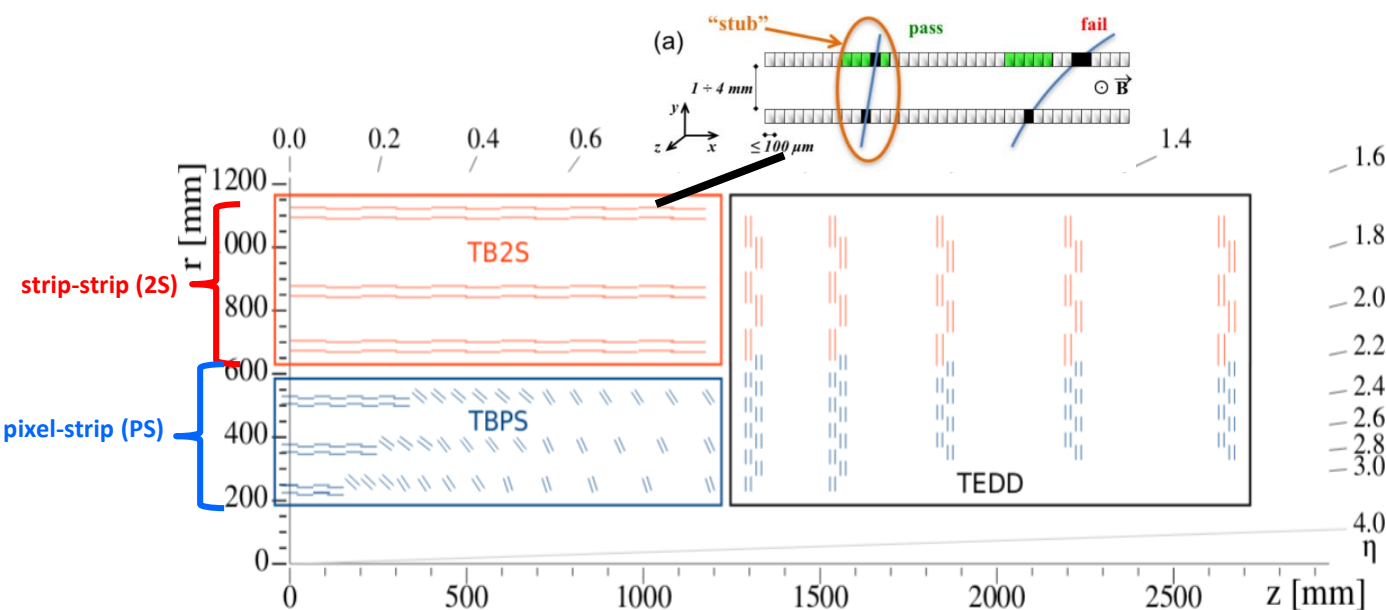


**Pixel readout chip in joint ATLAS + CMS development**  
6x smaller pixels;  $\sim 5$ x more hit rate;  $\sim 10$ x more trig. rates

	TBPX	TFPX	TEPX	Total
Active area [m <sup>2</sup> ]	0.99	1.89	1.99	4.87
Pixels	395 M	757 M	794 M	1.95 G
FE power [kW]	8	16	16	40



# Outer Tracker and the L1 track trigger : Overview



- Outer Tracker design has to provide tracks at 40 MHz to the L1-trigger ( $p_T > 2\text{GeV}$ )
  - The  $p_T$  modules select pair of hits (Stubs) compatible with track  $p_T > 2\text{GeV}$ .
  - Two layer track stubs remove low  $p_T$  tracks in trigger ( $< 2\text{GeV}$ )  $\rightarrow$  Data rate reduction 10x.
- Tilted modules in three OT layers to maintain geometric acceptance for the stubs.

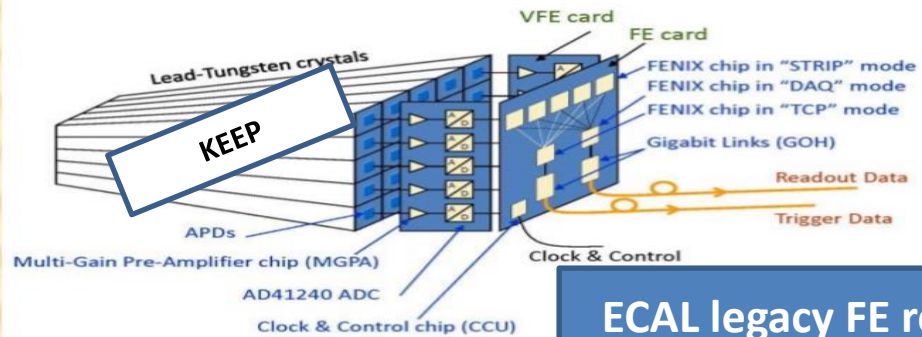
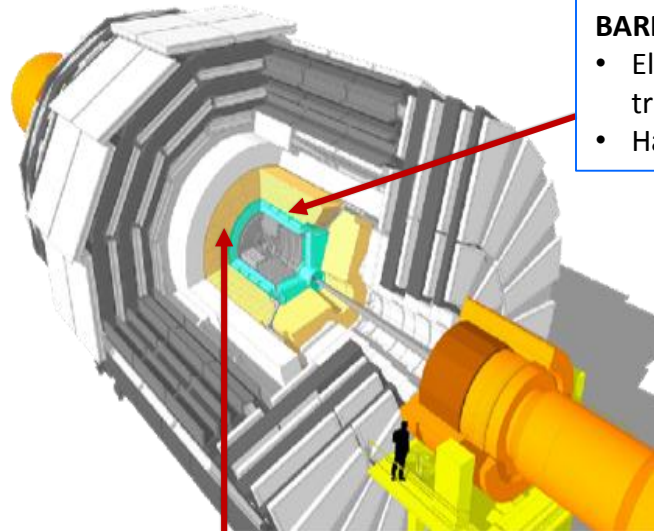
	2S module	PS module
Active area	138 m <sup>2</sup>	50 m <sup>2</sup>
Strip/pitch	5 cm x 90 $\mu\text{m}$	2.4 cm x 100 $\mu\text{m}$ (strips) 1.5 mm x 100 $\mu\text{m}$ (macro-pixels)
Channels	31M	11M(strips) + 170M (m-pixels)
FE power	5 W	8 W
Sensor power	~ 1 W	1.4 W

# Upgrades to the CMS calorimeters: EM + Hadronic



## BARREL CALORIMETERS

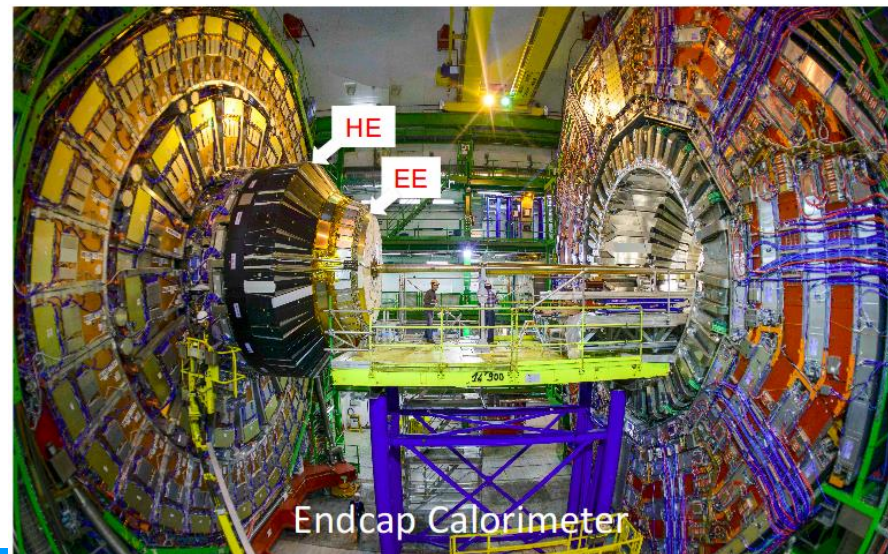
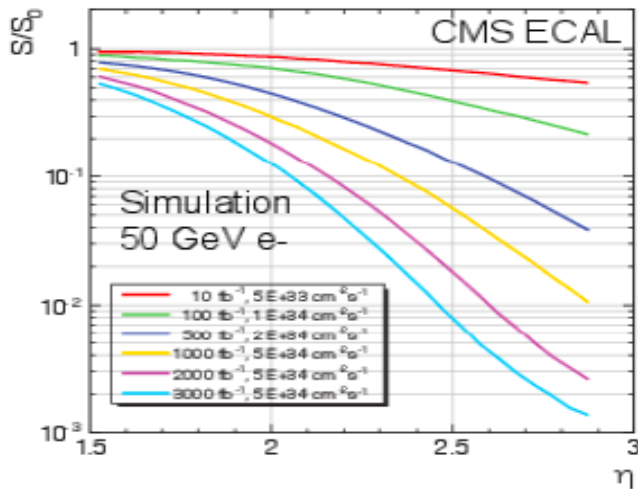
- Electromagnetic Calorimeter on-detector electronics replaced for precision timing and better trigger granularity
- Hadron Calorimeter electronics replaced for better signal strength and higher trigger rates



**ECAL legacy FE readout**

## ENDCAP CALORIMETERS

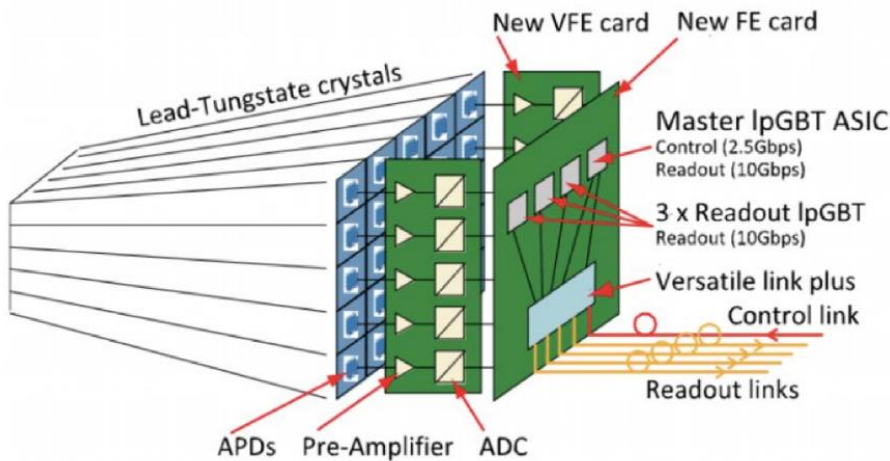
- Radiation-induced darkening is reducing the signal from the current scintillator-based endcap calorimeters  
 → The current endcaps will not survive with the radiation loads at the HL-LHC and need to be replaced



Endcap Calorimeter

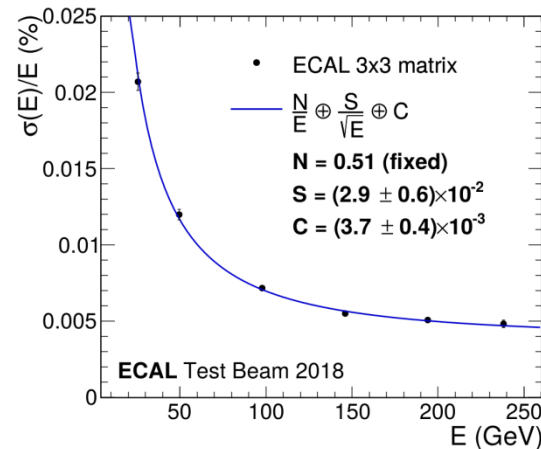
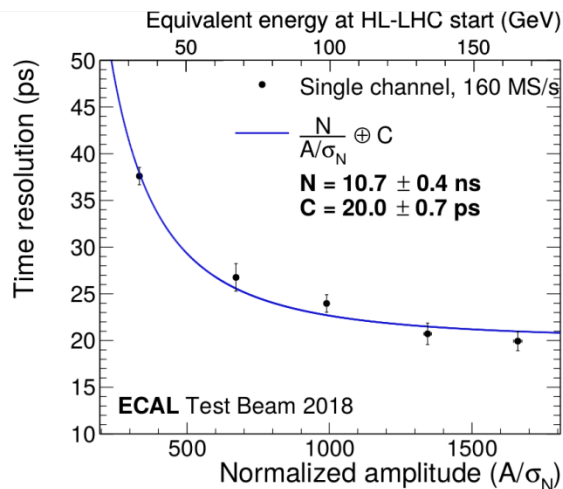


# Upgraded electronics for the Barrel calorimeters



- ECAL on detector electronics upgrades and operations updates
  - Digitization at 160 MHz to help discriminate against spikes (due to hadron interactions within the APD volume)
  - Faster response pre-amplifier to give 30ps timing for EM showers at ~50 GeV
  - Single crystal readout at trigger level.
  - Reduce the operating temperature from 18°C to 9°C to mitigate APD ageing effects.
- Replace all off-detector electronics components (HCAL+ECAL - ATCA)

## ECAL beam test results



- ECAL beam tests were performed to test the CATIA amplifier chip for the upgrades [using a commercially available ADC, FE and off-detector components].
  - **Single channel time resolution of ~30 ps obtained for an equivalent energy of 50 GeV**

See talk by C. Biino for ECAL upgrade details



# The CMS HGCal: design parameters



## Key Parameters:

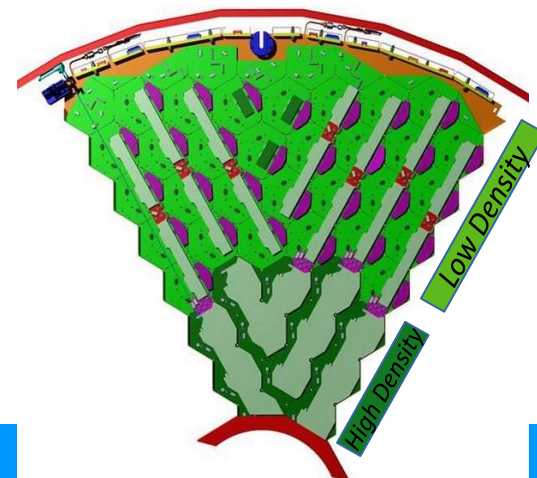
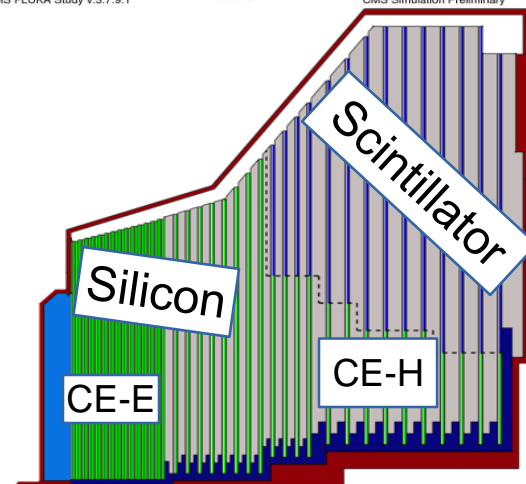
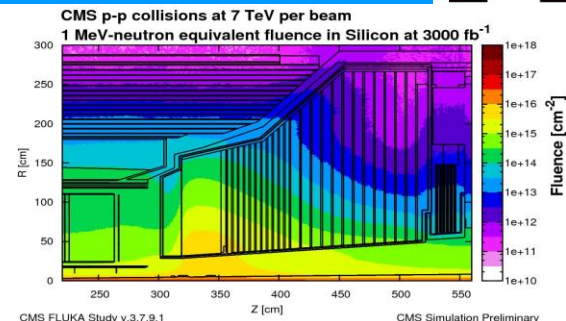
- The HGCal covers  $1.5 < |\eta| < 3.0$
- 215 ton/endcap, full system at -30C
- **620 m<sup>2</sup>** of silicon sensors in 30k modules
  - 6M Si channels, 0.5 or 1 cm<sup>2</sup> cell size
- 400 m<sup>2</sup> of scintillator in 4k boards
  - 240k scintillator channels, 4-30 cm<sup>2</sup> cell size

## Active Elements:

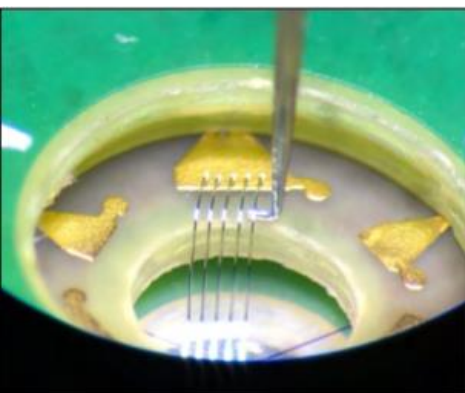
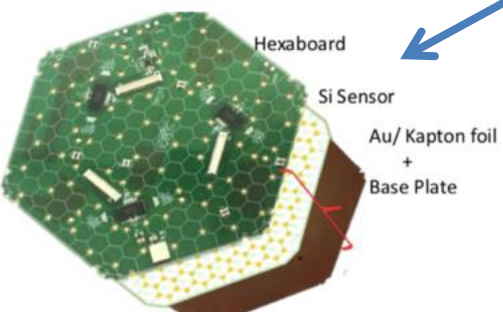
- Hexagonal modules based on Si sensors in CE-E and high-radiation regions of CE-H
- Scintillating tiles with SiPM readout in low-radiation regions of CE-H
- "Cassettes": multiple modules mounted on cooling plates with electronics and absorbers

## Detector Configuration:

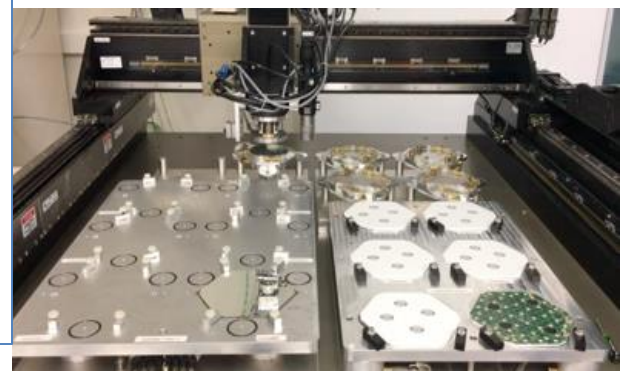
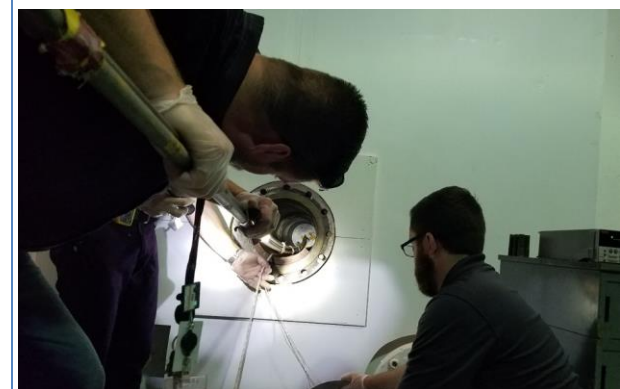
- Electromagnetic calorimeter (CE-E) : **Si**, Cu/CuW/Pb absorbers; 28 layers, 25.5  $X_0$  and 1.7  $\lambda$
- Hadronic calorimeter (CE-H) : **Si & scintillator**, steel absorbers; 22 layers and  $\sim 9.5 \lambda$  (including CE-E)



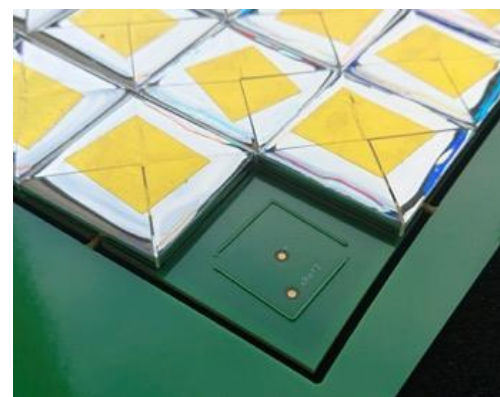
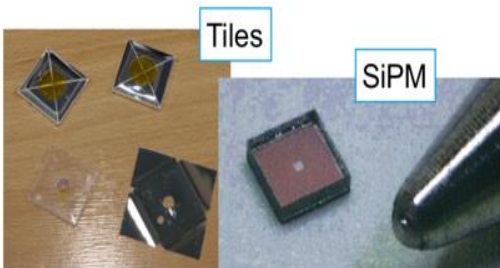
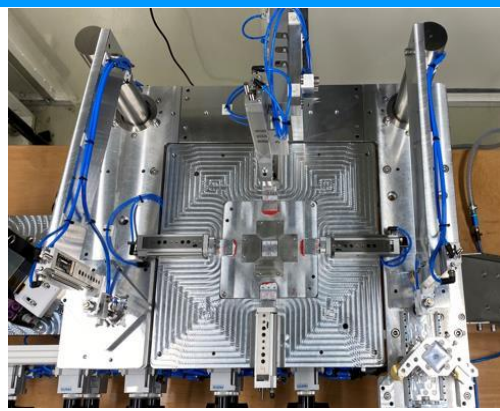
# The CMS HGCAL : Si sensor modules



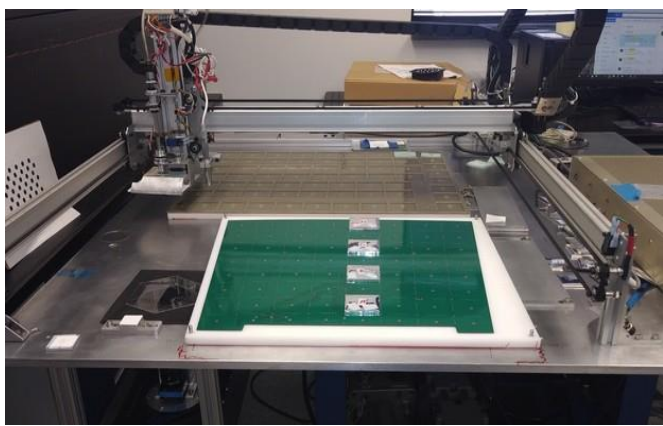
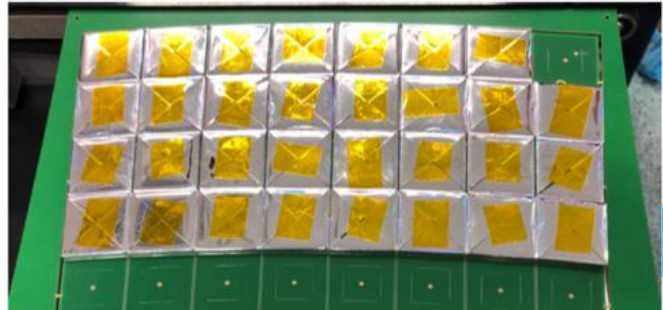
- The Silicon sensors are first use of 8" technology for large-scale HEP Sensors
  - **Hexagonal geometry to maximize use of wafer area**
- Robust module constructed from a baseplate, insulating layer, silicon sensor, and readout PCB
- Comprehensive test program including full-sensor tests with custom probe cards and reactor based neutron irradiations
- Automated assembly process using gantry and robotic wirebonder developed at UCSB
  - **Highly-repeatable, being replicated to five additional module assembly centers worldwide**



# The CMS HGCAL : SiPM-on-Tile modules

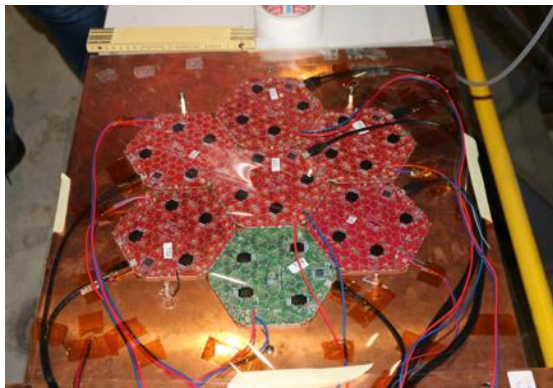


- Scintillator tiles will be produced using both injection molding and machining of cast scintillator
  - Tiles will be wrapped with ESR foil in an automated wrapping machine.
- SiPM photodetectors have been produced.
  - Sufficient signal-to-noise over the life of the experiment
- Automated construction of tile modules using pick-and-place of tiles onto tile PCB containing the SiPMs, readout chip, and other components

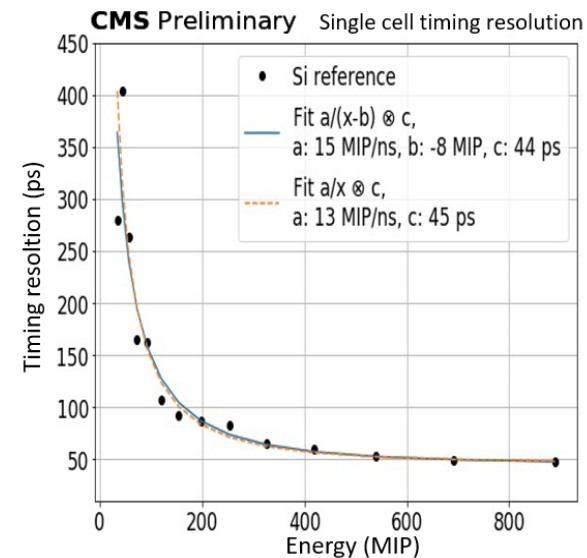
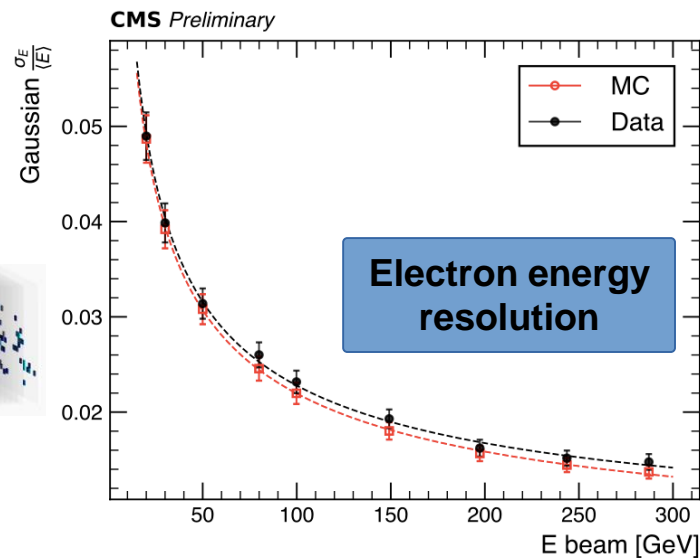
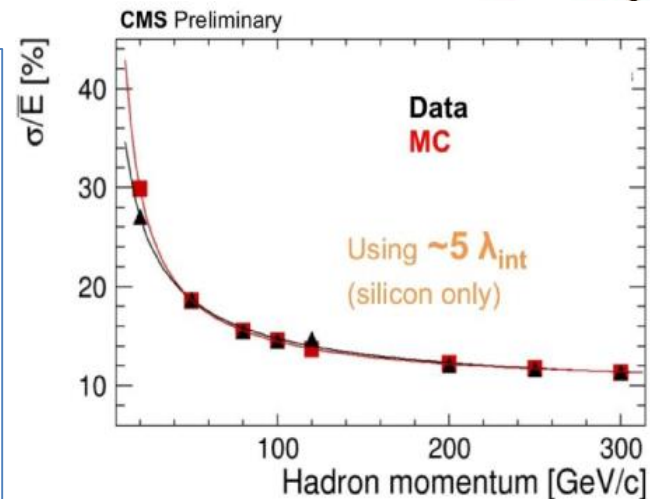
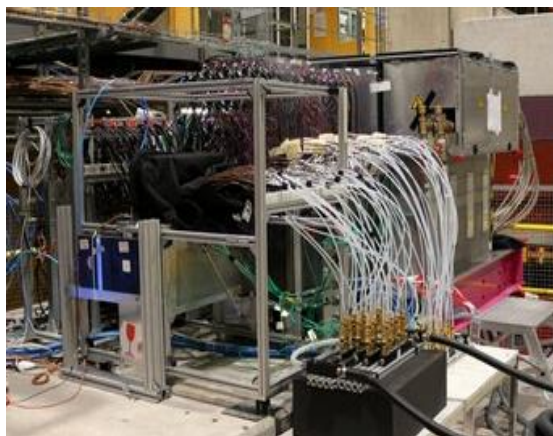




# The CMS HGCAL : Beam test results



- 28 EM layers, 12 silicon HAD layers, 39 scintillator layers from CALICE AHCAL
- Measured electrons, pions, and muons with energies from 20 GeV to 300 GeV
- Papers under preparation/in final collaboration review

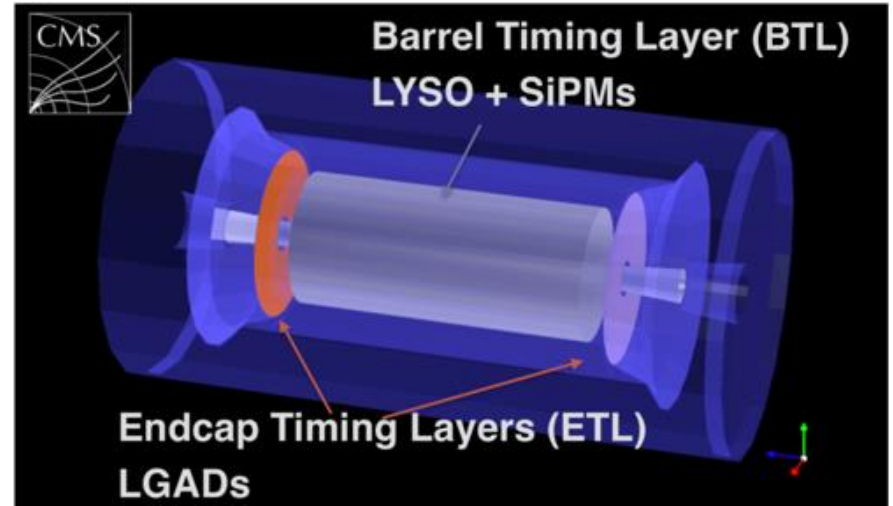
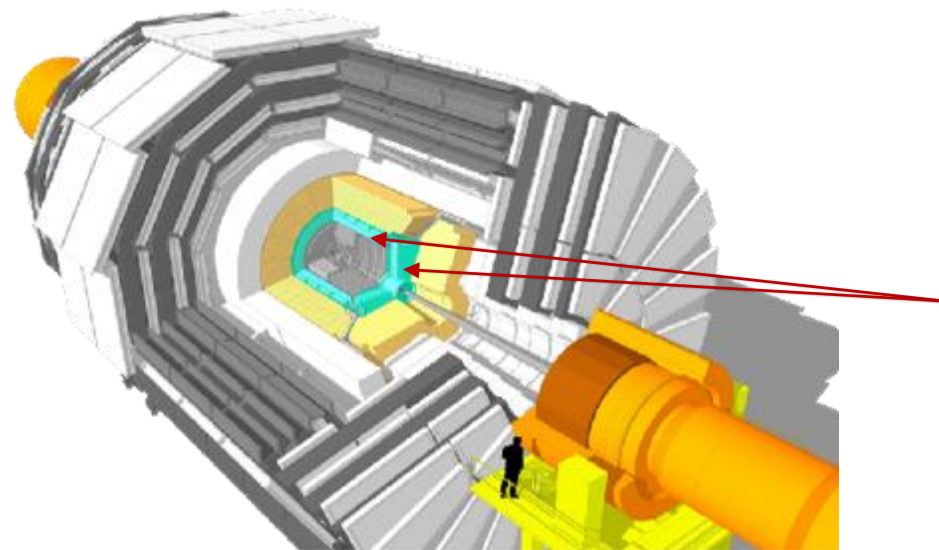


300 GeV pion starting showering in CE-H-Si



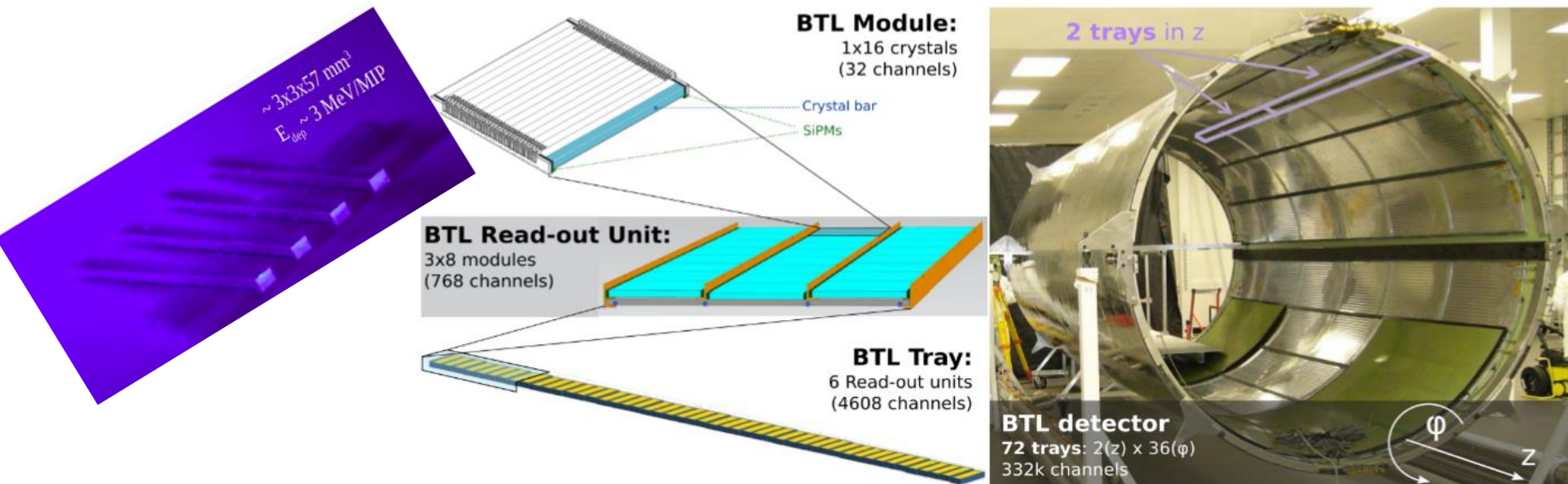


# The MIP Timing detector

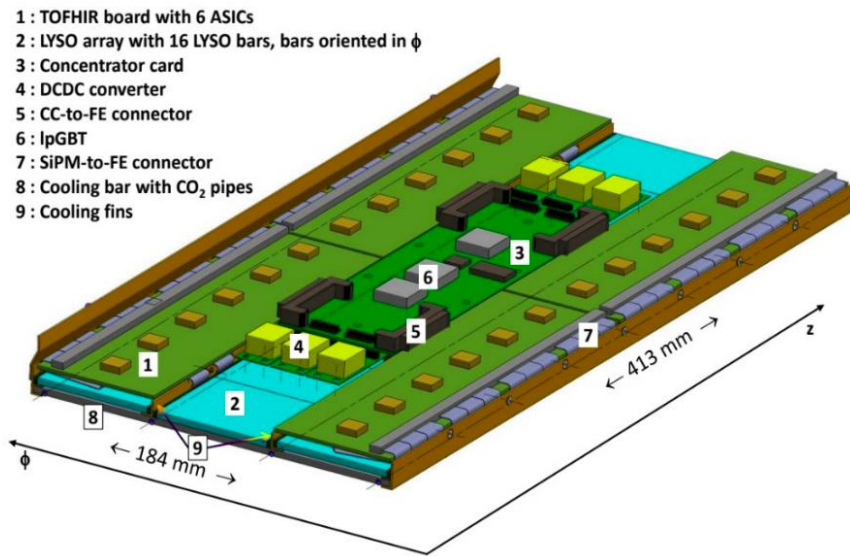


- Thin layers between the tracker and the calorimeters.
- Time resolution of 30 ps for MIPs at HL-LHC start and  $< 60$  ps at  $3000 \text{ fb}^{-1}$
- Hermetic coverage for  $|\eta| < 3.0$

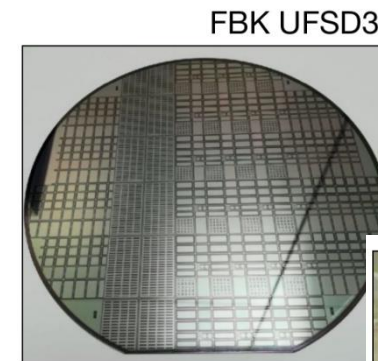
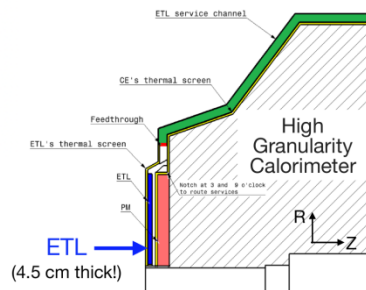
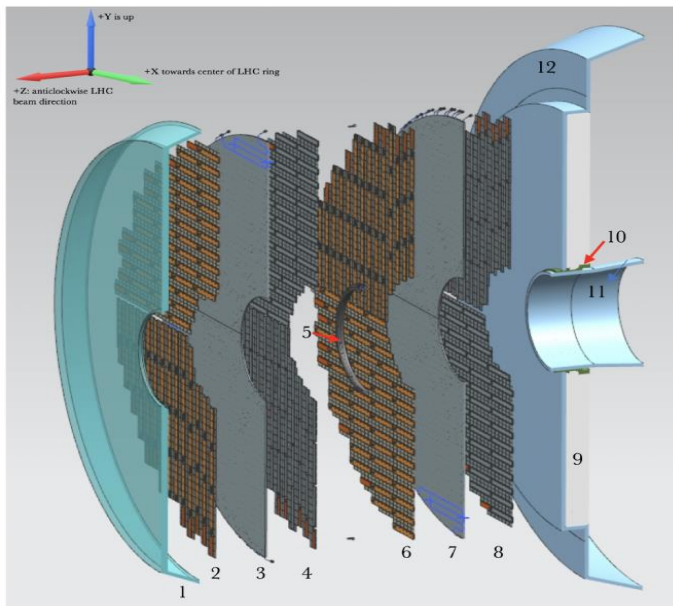
# The Barrel Timing Layer: Overview



- LYSO crystals with dual end SiPM readout
- Basic unit : 1x16 array of crystals ( $\sim 3 \times 3 \times 57 \text{ mm}^3$ )
- Arranged in trays and segmented in readout units
- Coverage of  $|\eta| < 1.45$ , surface  $\sim 38 \text{ m}^2$ , 332 k channels
- Nominal fluence :  $2 \times 10^{14} n_{\text{eq}}/\text{cm}^2$
- Time resolution 35-60 ps [start – end of life]
- Readout using TOFHIR board with 6 ASICS each reading up to 16 crystals (32 channels)

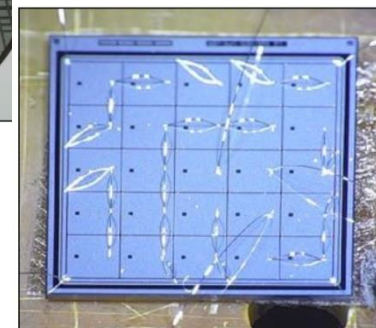


# The Endcap Timing Layer: Overview



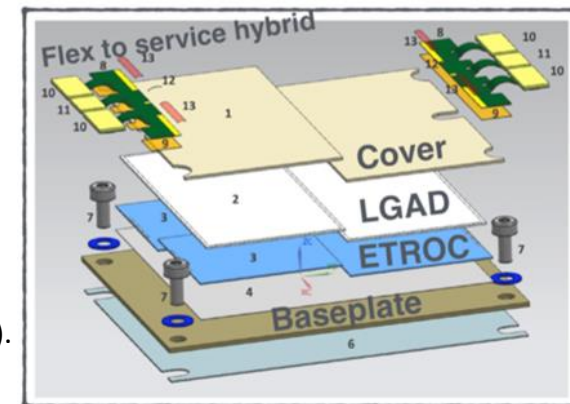
FBK UFSD3

LGAD prototype sensors



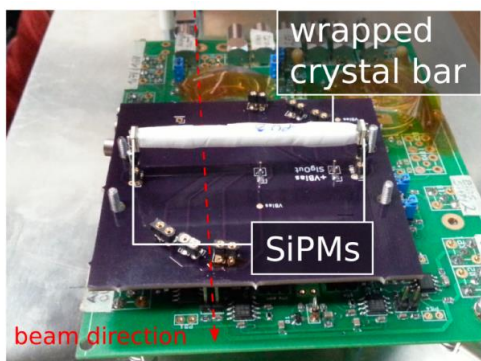
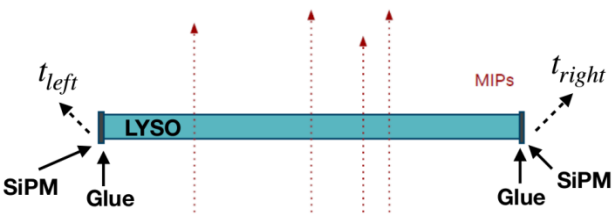
5x5 array from HPK

- Low Gain Avalanche Diodes (LGADs) with highly doped p+ region just below the n- implants.
- Two disks per endcap mounted on the HGCAL nose.
- Coverage of  $1.6 < |\eta| < 3.0$ , surface  $\sim 15.8 \text{ m}^2$ , 8.5 M channels
  - $1.3 \times 1.3 \text{ mm}^2$
- Nominal fluence :  $2 \times 10^{15} n_{eq}/\text{cm}^2$
- Time resolution 30 - 45 ps [start – end of life]
- Sensors are organized in arrays of 16x32 with a size of 21 x 42 mm<sup>2</sup>
  - Two ETL ASICs (ETROC) needed to readout one module (each ETROC has 16x16 channels).
  - Each ETROC consists of pre-amplifier, discriminator and a TDC.

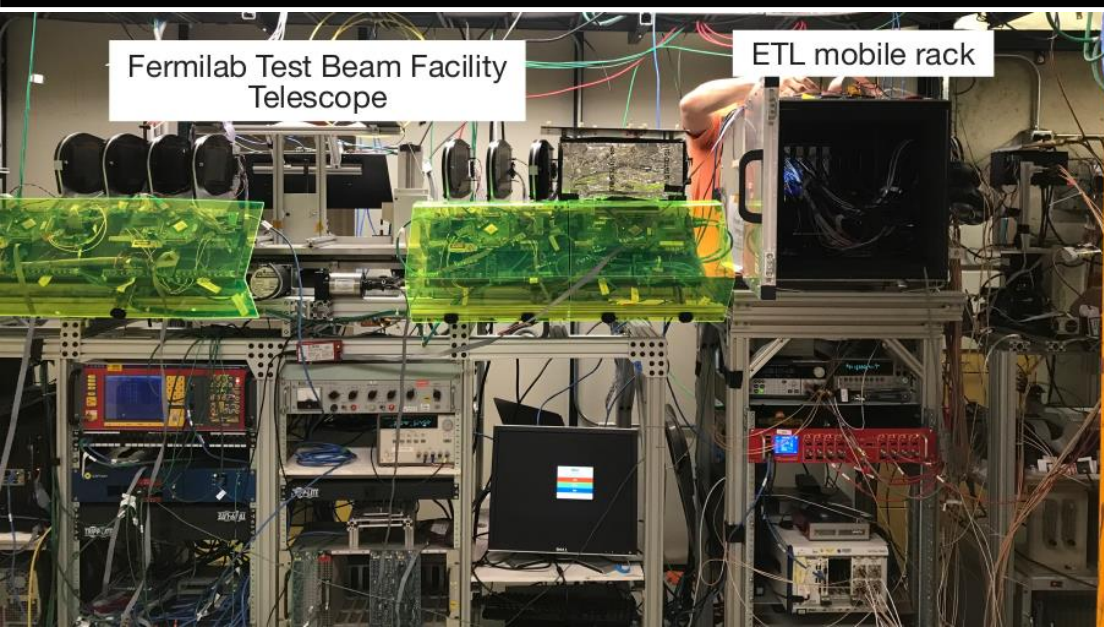
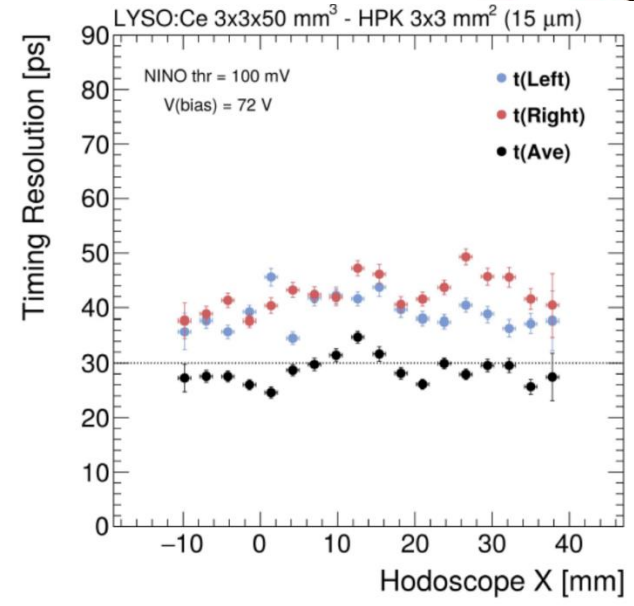




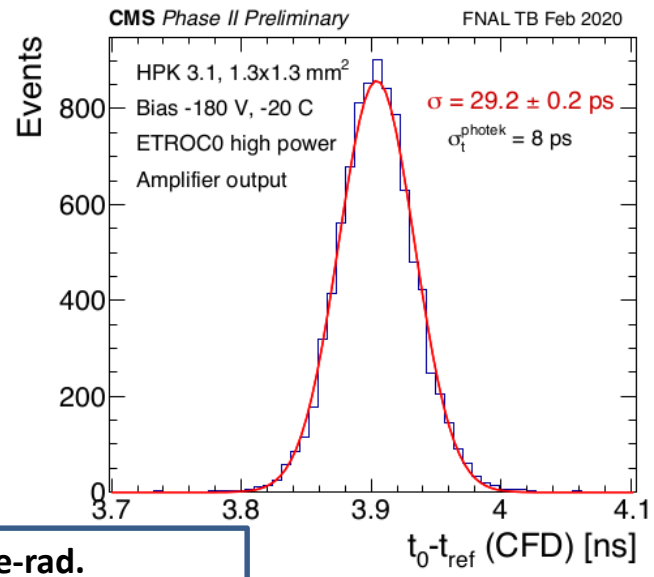
# Results from Beam Tests



• Achieved 30 ps time resolution per BTL sensor before irradiation



• Achieved 30-35 ps time resolution for ETL sensors operating above 20 fC, pre-rad.



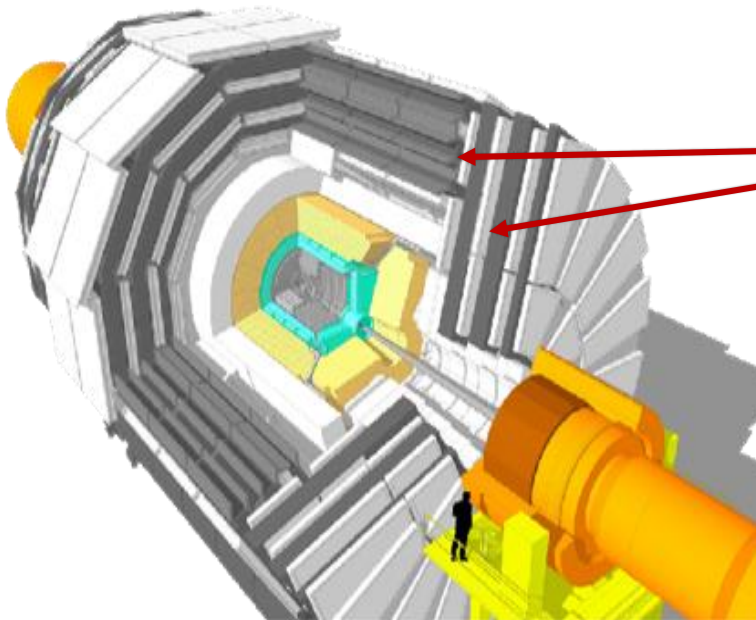


# Muon detector upgrades



Precision measurements crucially depend on how well we can reconstruct muons.

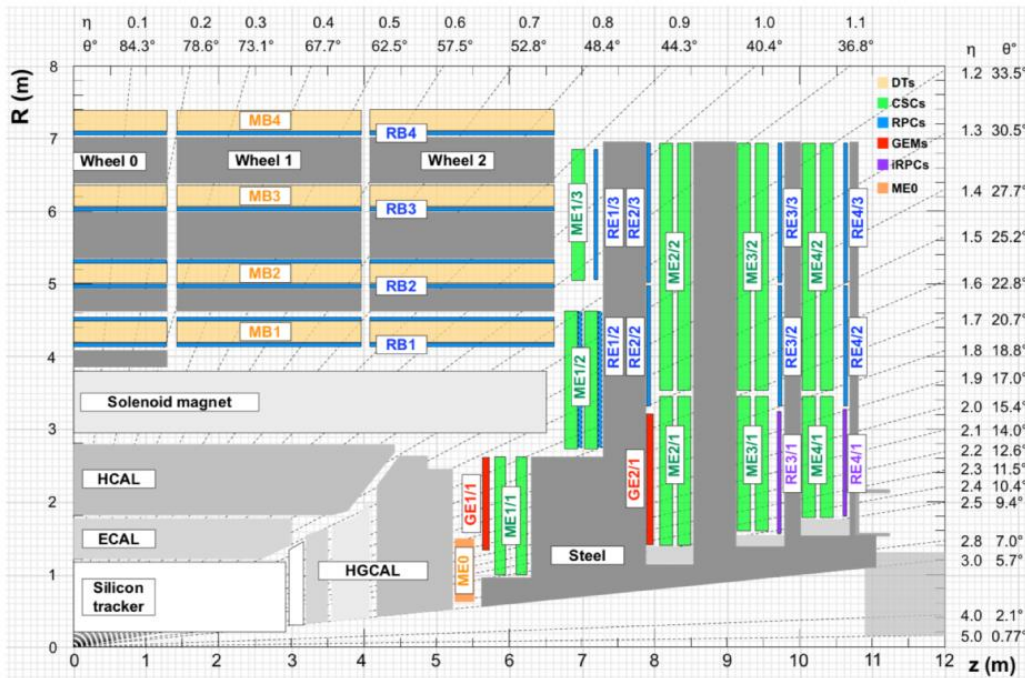
→ The ultimate measurement of the Higgs boson mass is expected to be obtained from the  $H \rightarrow ZZ \rightarrow 4\mu$  channel at the HL-LHC



## Muon system upgrades

- Extended GEM coverage to  $\eta \simeq 3$
- DT & CSC new FE/BE readout
- RPC back-end electronics
- New GEM/RPC  $1.6 < \eta < 2.4$

# Muon detector upgrades : Overview



## New stations:

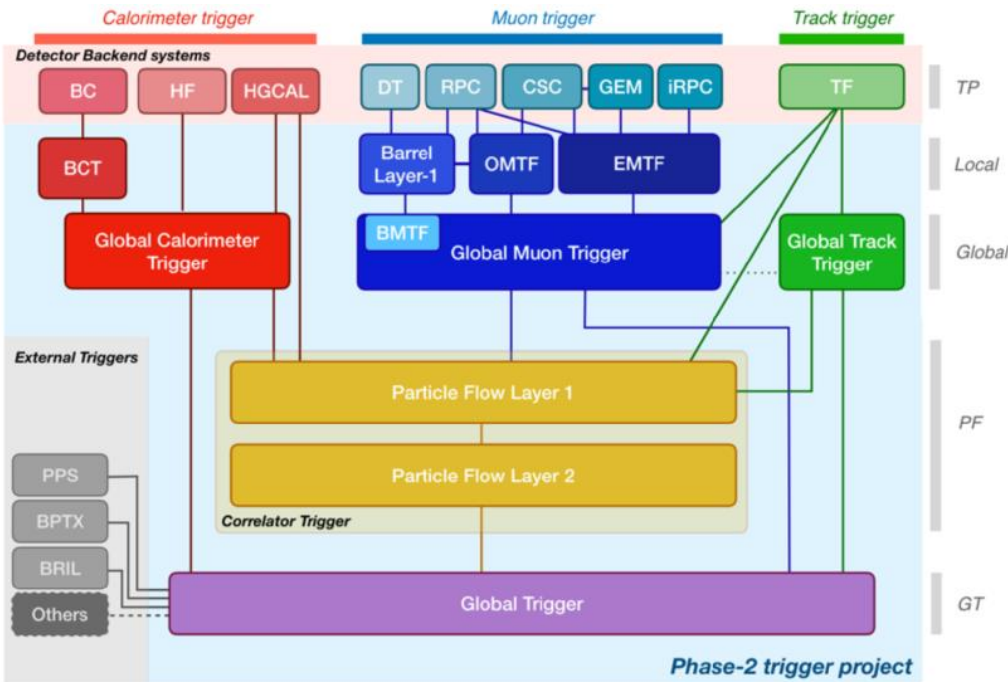
- GEM: **GE1/1**, GE2/1, iRPC: RE3/1, RE4/1:  $1.6 \leq \eta \leq 2.4$ ,
- GEM: ME0 extended coverage  $2.0 \leq \eta \leq 2.8$

The current muon detectors are expected to withstand the HL-LHC radiation levels. The upgrades focus on :

- Upgrading/replacing the electronics of the existing DTs, CSCs and RPCs to ensure longevity and to improve the trigger performance.
- Extending the coverage of the muon system to  $\eta \simeq 3$  in order to benefit from the extension of the tracker and HGCAL as well as new features of the L1-trigger

See talk by C. Aruta for the Muon system upgrade details

# Upgrades to the Trigger and DAQ



## The Trigger parameters for HL-LHC

- Trigger primitives input rate  $\sim 63$  Tb/s
- L1 trigger rate of  $\sim 750$  kHz @ 200PU (now 100 kHz)
- L1 latency of  $12.5 \mu\text{s}$  (now  $3.4 \mu\text{s}$ )
- High-Level Trigger (HLT) rate  $\sim 7.5$  kHz (now 1 kHz)

- **Take advantage of the new detector capabilities at L1**
  - Track trigger - better lepton  $p_T$  resolution - @ 40 MHz
    - **More sophisticated algorithms for pattern recognition in general.**
  - More granular calorimeter information.
  - Additional muon chambers for  $\eta > 1.6$
  - Sub-detector electronics upgrade to handle higher rate
    - **Made possible by high speed optical links (10 Gb/s) and GHz FPGA's**





- The HL-LHC will enable measurements of Higgs boson properties with a very high precision as well as significantly extend the scope of new physics searches.
- The main challenges for the CMS detector are to cope with the high levels of radiation and to mitigate the impact of high pileup.
- The CMS collaboration is harnessing state-of-the-art technologies to be able to fully exploit the HL-LHC luminosity.
- The Phase-2 upgrades program is well into the development phase and preparing for the production phase.
  - The TDRs of the main detector and the Level 1 trigger are approved.
  - The small delay due to COVID-19, is possible to be absorbed in the planned contingency in the schedule.



# BACKUP

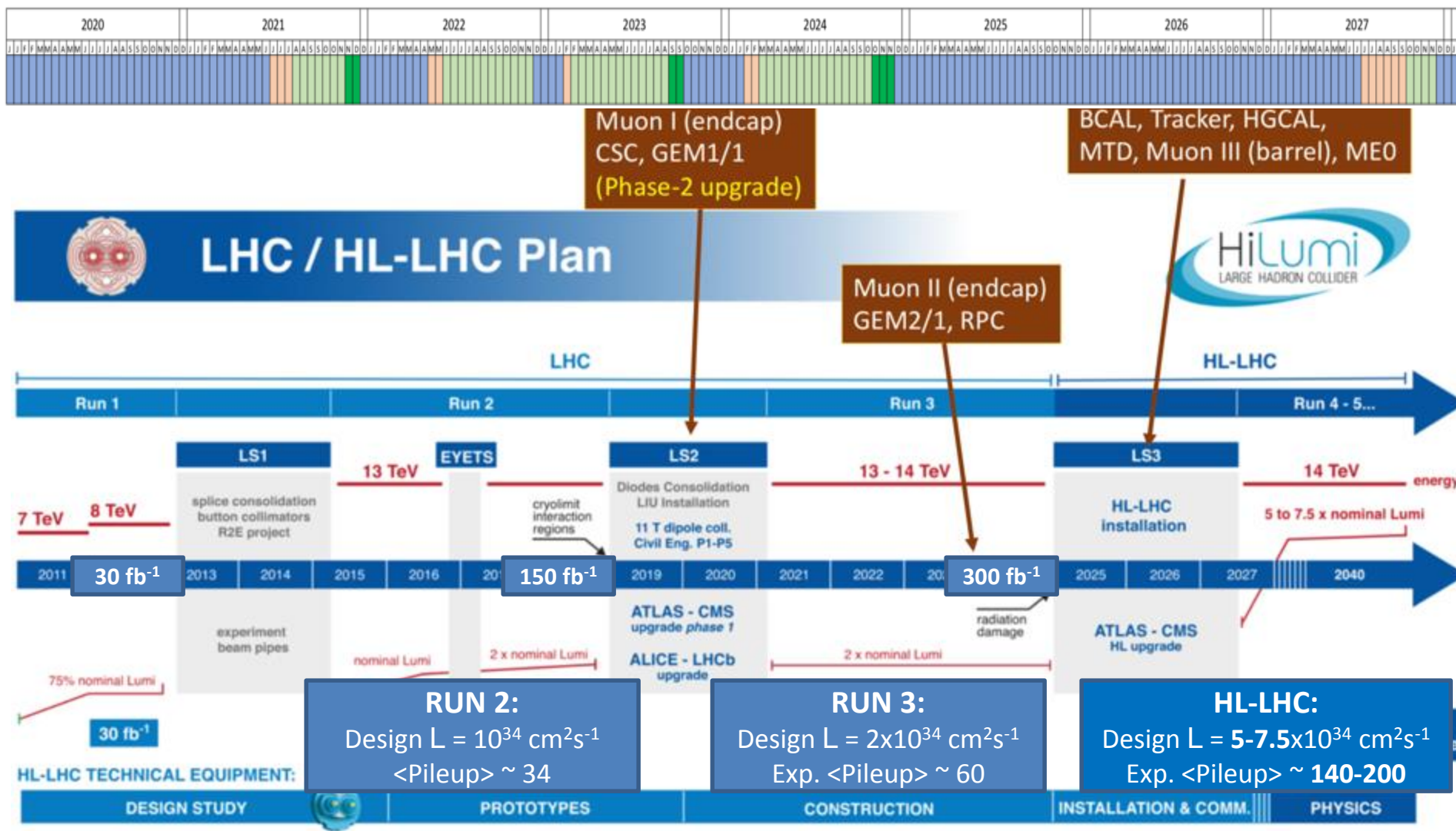
# CMS HL-LHC Upgrade: Schedule



Calendar Year	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	20			
Long Shutdowns				LS2							LS3				
Tracker Outer	Design - Demo.		TDR	Engineering - Prototyping				EDR	Pre-production - Production - Integration				Float	Inst. - Comm.	
Tracker Pixel	Design - Demo.		TDR	Engineering - Prototyping				EDR	Pre-production - Production - Integration				Float	Inst. Com.	
Barrel Calorimeters ECAL/HCAL	Design - Demo.		TDR	Engineering - Prototyping				EDR	Pre-production	ESR	Pre-production - Production		Float	Installation	Commissioning
Calorimeter Endcap	Design - Demo.		TDR	Engineering - Prototyping				EDR	End cap Pre-production - Production - Integration - Commissioning				Float	Installation - Commissioning	
Muons GEM1	Engin.	EDR	Pre-prod. - Production - Integ.		Inst.										
Muons CSC	FE Engin.	Pre-production		ESR	Production	FE Installation	ODMB design		ESR	ODMB/BE pre-production - Production			Float	Installation - Commissioning	
Muons DT	Engineering - Prototyping		TDR	Pre-production		ESR	Production			Float	Installation - Commissioning				
Muons RPC	Design - Demo.		TDR	Engineering - Prototyping				EDR	Pre-production	ESR	Production	Float	Inst.		
Muons GEM2	Design - Demo.		TDR	Engineering - Prototyping		EDR	Pre-production	ESR	Barrel Link System Production		Float	Installation	Commissioning		
Muons GEM0	Design - Demo.		TDR	Engineering - Prototyping				EDR	ESR	Pre-production - Production		Float	Inst.	Commissioning	
MIP-Timing Detector Barrel	Design - Demo.		TP	Engin. - Proto.		TDR	Pre-prod. - Production - Integration in TST			EDR	Float	Integration, Commissioning			
MIP-Timing Detector Endcap	Design - Demo.		TP	Engin. - Proto.		TDR	Pre-production - Production - Integration in HGCAL				EDR	Float	Commissioning		
L1-Trigger	Conceptual Design		ITDR	Design - Proto. - Demo.			TDR	Pre-production			ESR	Production & Integration testing		Float	Installation - Commissioning
DAQ/HLT	Design		ITDR	Electronics Proto. - Demo. V1				TDR	Pre-pro - Demo. V2		EDR	Electronics production - Slice			Inst. - Commissioning
BRIL Luminosity, Beam and Radiation Monitors	Design and prototyping			TDR	Engineering development			EDR	Production & Integration			Installation - Commissioning			



# CMS HL-LHC Upgrade: Timeline updated



**RUN 2:**  
 Design L = 10<sup>34</sup> cm<sup>2</sup>s<sup>-1</sup>  
 <Pileup> ~ 34

**RUN 3:**  
 Design L = 2x10<sup>34</sup> cm<sup>2</sup>s<sup>-1</sup>  
 Exp. <Pileup> ~ 60

**HL-LHC:**  
 Design L = 5-7.5x10<sup>34</sup> cm<sup>2</sup>s<sup>-1</sup>  
 Exp. <Pileup> ~ 140-200

# HL-LHC tracker : 2S module

